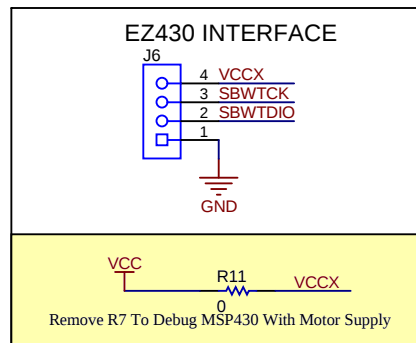
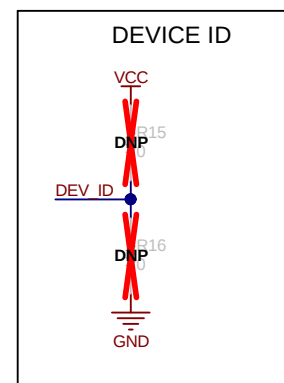
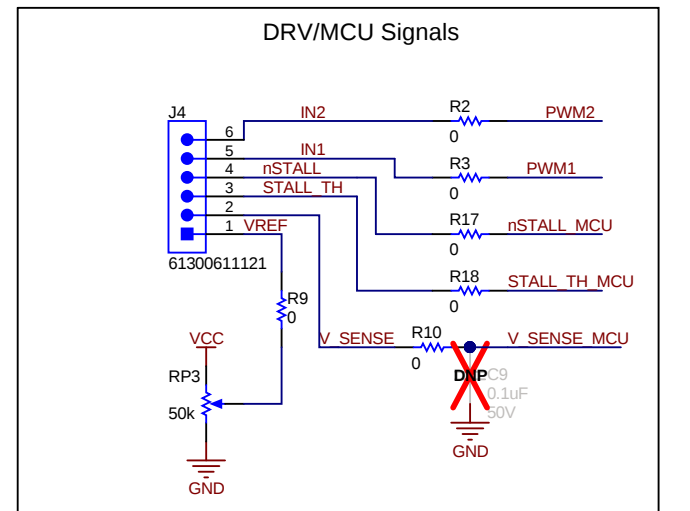
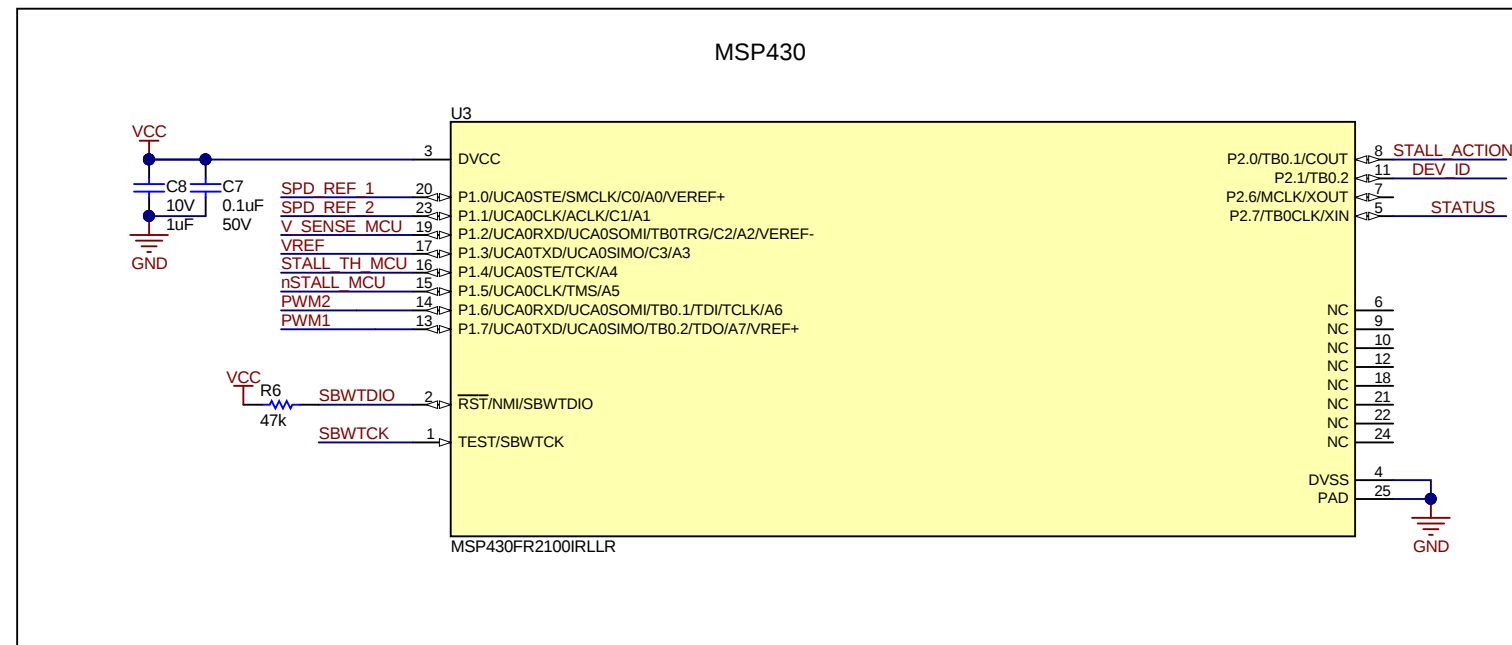
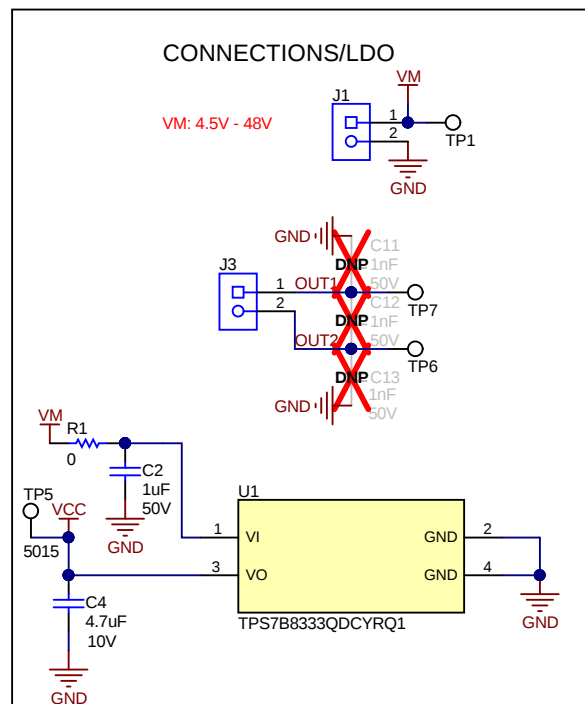
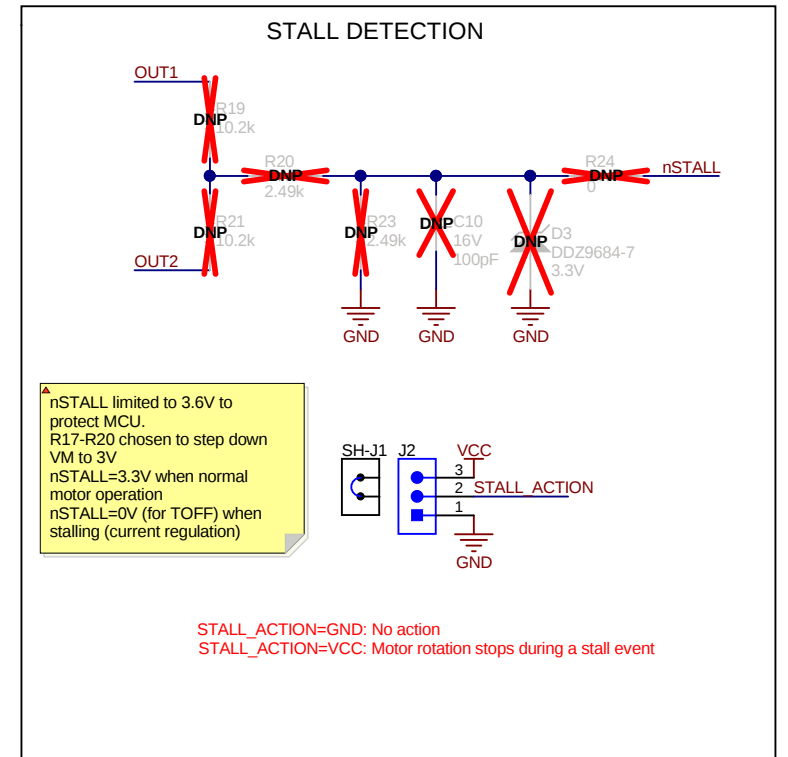
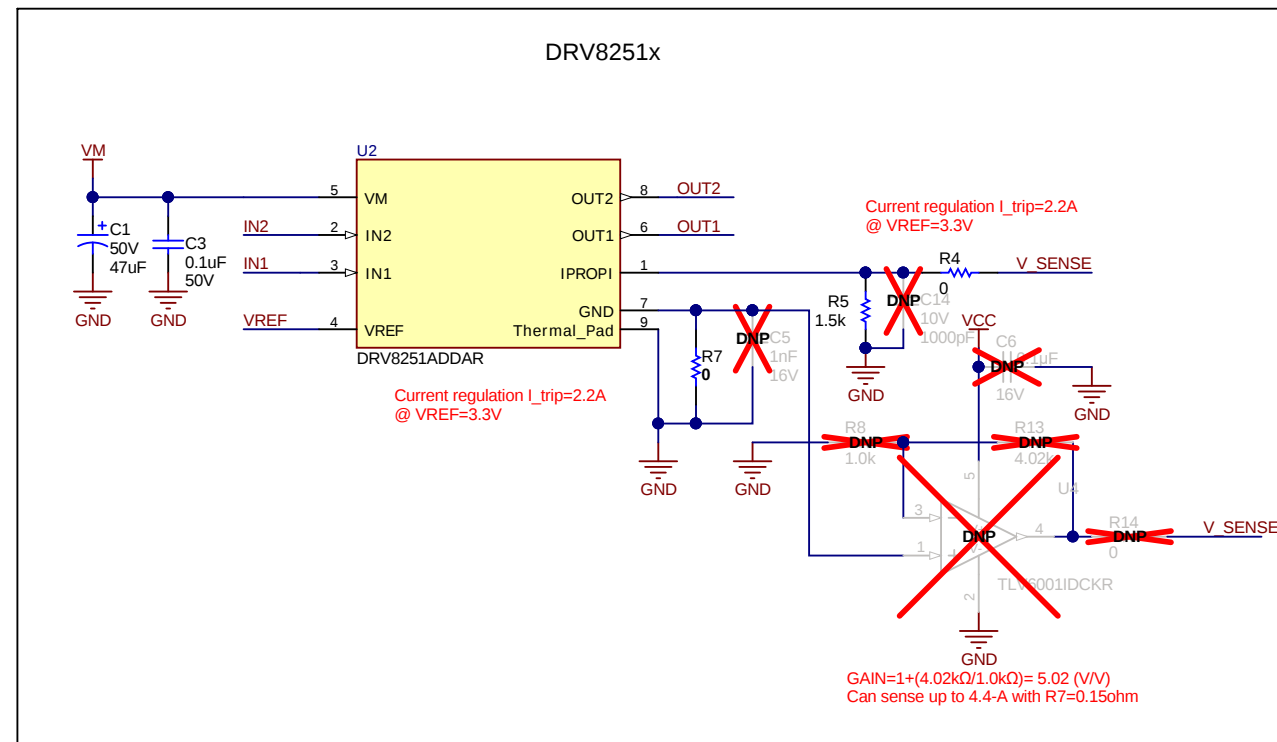


EXTERNAL SIGNALS





PCB
LOGO

FCC disclaimer

PCB
LOGO

Texas Instruments

PCB
LOGO

WEEE logo



CE Mark

LBL1

PCB Label

THT-14-423-10
Size: 0.65" x 0.20 "

LOGO1



CAUTION HOT SURFACE

ZZ1

Label Assembly Note

This Assembly Note is for PCB labels only

ZZ2

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

ZZ5

Assembly Note

Board material shall meet UL MOT of 130C

Variant/Label Table

Variant	Label Text
001	DRV8251AEVM
002	DRV8251EVM

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Orderable: DRV8251EVM	Designed for: Public Release	Mod. Date: 10/4/2021
TID #: N/A	Project Title: DRV8251xEVM	
Number: MD039	Rev: A	Sheet Title:
SVN Rev: Not in version control	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: MD039A_Hardware.SchDoc	Size: B
Engineer: Pablo Armet	Contact: http://www.ti.com/support	